SK 8 BGD 065 E



SEMITOP® 2

1-phase bridge rectifier+3-phase bridge inverter

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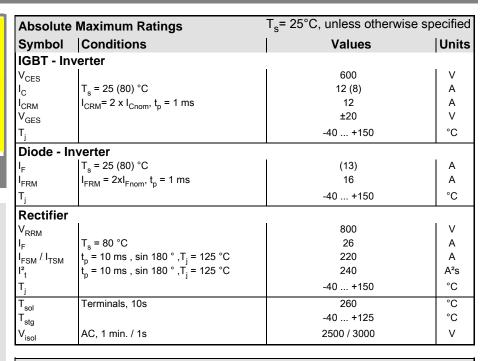
Preliminary Data

Features

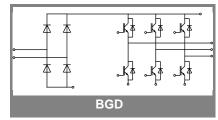
- Compact design
- · One screw mounting
- Heat transfer and isolation through direct copper bonded alumium oxide ceramic (DCB)
- N-channel homogeneous silicon structure (NPT-Non punch-through IGBT)
- · High short circuit capability
- Low tail current with low temperature dependance

Typical Applications*

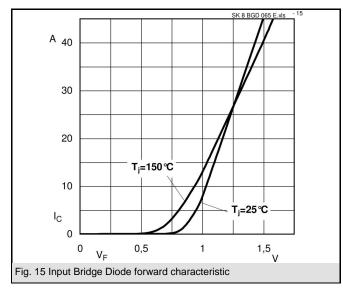
- Inverter
- Servo drives

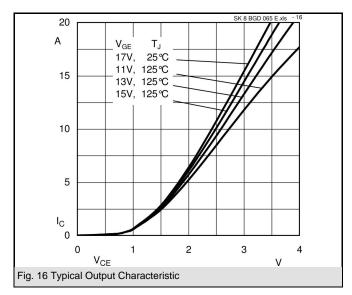


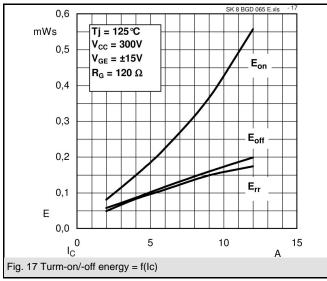
| Characteristics | | T _s = 25°C, | T _s = 25°C, unless otherwise specified | | | |
|----------------------|---|------------------------|---|-------|-------|--|
| Symbol | Conditions | min. | typ. | max. | Units | |
| IGBT - In | verter | | | | • | |
| V_{CEsat} | I _C = 6 A, T _i = 25 (125) °C | | 2 (2,2) | | V | |
| $V_{GE(th)}$ | $V_{GE} = V_{CE}$, $I_C = 0.5 \text{ mA}$ | 3 | 4 | 5 | V | |
| V _{CE(TO)} | T _i = 25 °C (125) °C | | 1,2 (1,1) | | V | |
| r _T | T _j = 25 °C (125) °C | | 133 (183) | | mΩ | |
| C _{ies} | $V'_{CE} = V_{GE} = 0 \text{ V, f} = 1 \text{ MHz}$ | | - | | nF | |
| C _{oes} | $V_{CE} = V_{GE} = 0 \text{ V, f} = 1 \text{ MHz}$ | | - | | nF | |
| C _{res} | $V_{CE} = 25 V_{GE} = 0 V, f = 1 MHz$ | | 0,03 | | nF | |
| $R_{th(j-s)}$ | per IGBT | | | 2,6 | K/W | |
| t _{d(on)} | under following conditions | | 20 | | ns | |
| t _r ` | $V_{CC} = 300 \text{ V}, V_{GE} = \pm 15 \text{ V}$ | | 25 | | ns | |
| $t_{d(off)}$ | $I_C = 6 \text{ A}, T_j = 125 ^{\circ}\text{C}$ | | 145 | | ns | |
| $t_{\rm f}$ | $R_{Gon} = R_{Goff} = 120 \Omega$ | | 25 | | ns | |
| Ė _{on} | inductive load | | 0,22 | | mJ | |
| E_{off} | | | 0,12 | | mJ | |
| Diode - I | nverter | | | | | |
| $V_F = V_{EC}$ | I _F = 8 A, T _i = 25(125) °C | | 1,35 | | V | |
| V _(TO) | T _i = °C (125) °C | | (8,0) | (0,9) | V | |
| r _T | T _i = °C (125) °C | | (44) | | mΩ | |
| $R_{th(j-s)}$ | per diode | | | 2,7 | K/W | |
| I _{RRM} | under following conditions | | 4,2 | | Α | |
| Q _{rr} | I _F = 8 A, V _R = 300 V | | 0,65 | | μC | |
| Err | V _{GE} = 0 V, T _j = 125 °C | | | | mJ | |
| | di _{F/dt} = -120 A/μs | | | | | |
| Diode re | ctifier | • | | | I | |
| V_{F} | I _F = 20 A, T _i = 25() °C | | 1,1 | | V | |
| $V_{(TO)}$ | T _i = 150 °C | | 0,85 | | V | |
| r _T | T _j = 150 °C | | 15 | | mΩ | |
| R _{th(j-s)} | per diode | | | 2,15 | K/W | |
| | tur sensor | • | | | | |
| R _{ts} | %, T _r = () °C | | () | | Ω | |
| Mechani | cal data | • | | | | |
| w | | | 19 | | g | |
| M_s | Mounting torque | | | 2 | Nm | |

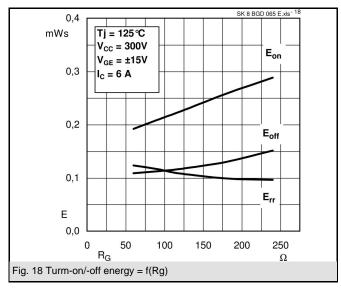


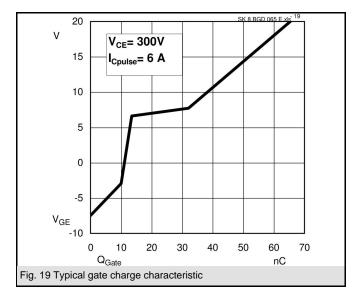
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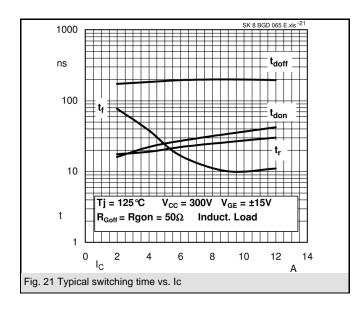


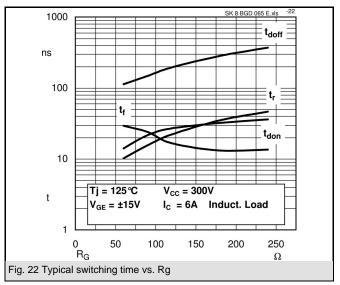


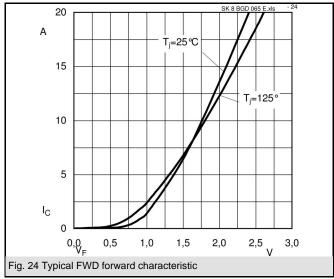


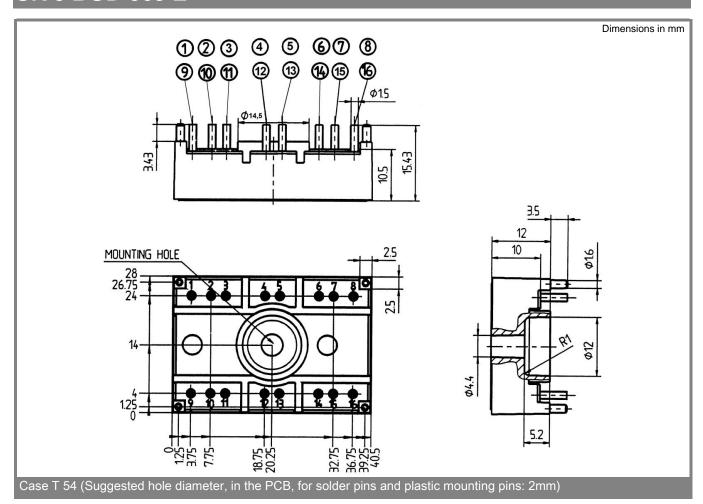


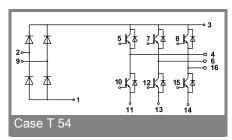
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This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

^{*} The specifications of our components may not be considered as an assurance of component characteristics. Components have to be tested for the respective application. Adjustments may be necessary. The use of SEMIKRON products in life support appliances and systems is subject to prior specification and written approval by SEMIKRON. We therefore strongly recommend prior consultation of our personal.